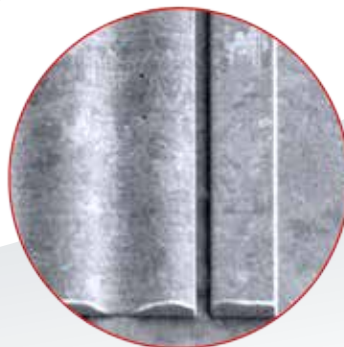
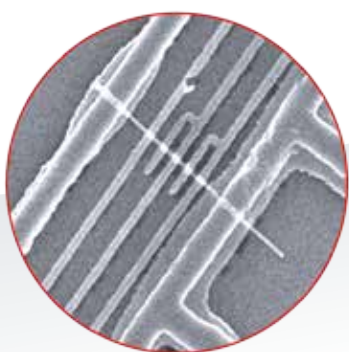


# NanoFrazor Explore

Revolutionizing  
Nanofabrication

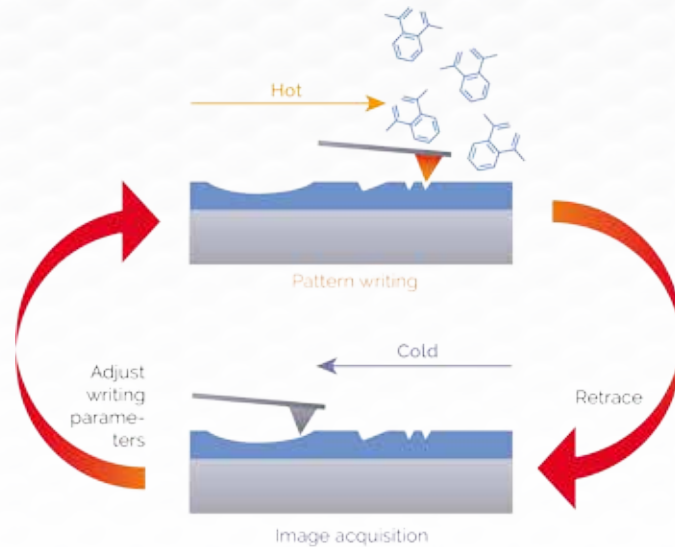


## NanoFrazor Explore

### THE FIRST HYBRID MIX&MATCH NANO- AND MICROLITHOGRAPHY TOOL

The NanoFrazor Explore takes nanofabrication to a new level. The NanoFrazor technology is commercially available only since 2014, but its unique capabilities have already enabled many revolutionary nanotechnology devices and discoveries.

NanoFrazor lithography systems are based on thermal scanning probe lithography. Core of the NanoFrazor technology is an ultra-sharp heatable probe tip which is used for writing and simultaneous inspection of complex nanostructures. The heated tip creates arbitrary, high-resolution nanostructures by local sublimation of resists. Standard pattern transfer methods like lift-off or etching can be applied.



Patented "Closed-Loop Lithography" ensures high patterning accuracy

#### PPA - the main resist for NanoFrazor technology

- Polyphthalaldehyde (PPA) decomposes and sublimates without redeposition upon heating by tip or laser
- PPA is suitable for many pattern transfer processes (lift-off, etching, molding, ...). We provide support and an extensive recipe book.
- PPA is commercially available worldwide (Allresist GmbH, Germany)
- Contact us for info on other resists and transfer processes

## HYBRID MIX & MATCH DIRECT WRITE LITHOGRAPHY

Since 2019, the NanoFrazor Explore is also equipped with a laser writer module. The increased write speed at micrometer resolution makes the Explore the first real alter-

native to expensive and complex direct-write nanolithography methods like electron beam lithography.

#### Laser writing

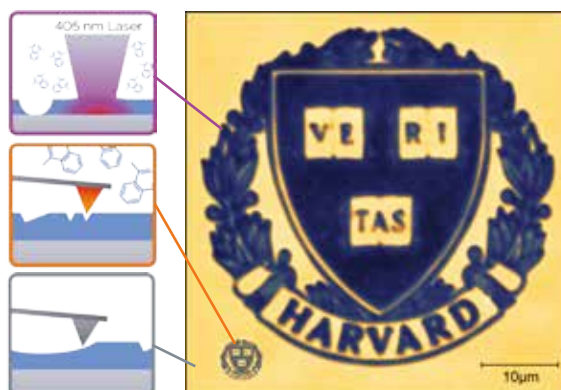
Fast direct resist sublimation for large-area patterning, e.g. contact wires and pads

#### Thermal probe writing

High precision and high resolution for the critical parts of the nanodevice

#### Metrology, inspection and alignment

In-situ high-speed AFM with the same tip before, during or after patterning. No wet development required as the resist is removed directly

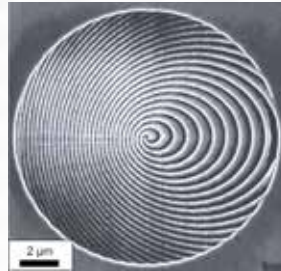


Harvard micro- and nano-logos written 30 nm deep into PPA resist and imaged by NanoFrazor AFM

Courtesy of Harvard CNS

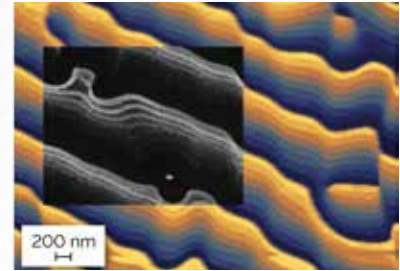
### 3D GRAYSCALE NANOLITHOGRAPHY

- Patterning depth can be set for each position of the tip (grayscale value of each pixel)
- Closed-Loop Lithography enables unprecedented accuracy (< 1 nm error demonstrated for more than 16 individual depth levels)



3D phase plate etched from PPA into SiN membranes for TEM optics

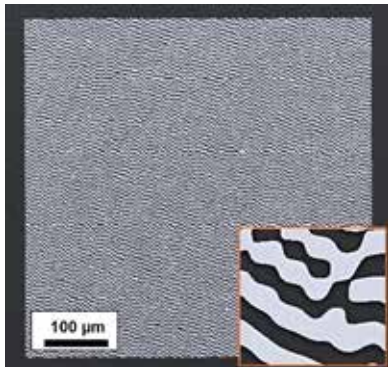
Courtesy of EPFL and KIT



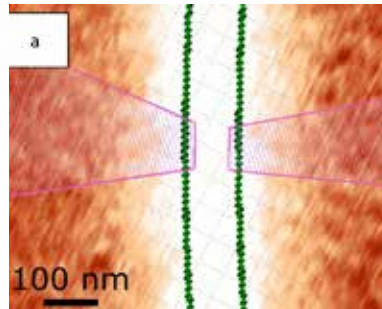
Multilevel hologram written into PPA and simultaneously imaged. Inset is an SEM image after 10x-amplification etch transfer in Si

Courtesy of Sun Yat-Sen University

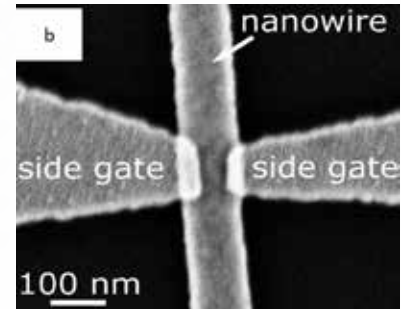
### MARKERLESS OVERLAY & STITCHING



Reflective hologram (made with Au lift-off) consisting of 100 000 000 pixels and stitched from 50 μm write fields using an AFM correlation stitching technique.

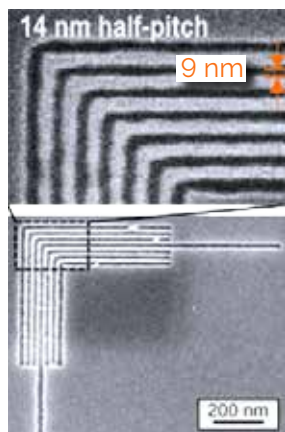


Markerless overlay of metal electrodes on top of a nanowire buried under resist stack. a) Detect nanowire location (green) and draw layout on AFM image (pink). b) SEM after lift-off.



- Accurate overlay and stitching achieved by in-situ AFM (sub-10 nm accuracy demonstrated)
- Features buried under resist (flakes, wires, etc) are used as natural markers
- Automated correlation stitching of write fields

### ULTRA-HIGH RESOLUTION



Silicon fins and trenches etched from PPA resist.

Courtesy of IBM Research and imec

- Ultra-sharp tips enable ultra-high resolution (< 10 nm half-pitch demonstrated in resist)
- No proximity effect corrections required

### OTHER UNIQUE CAPABILITIES

- **Low damage:** No charged particles beam, hence better device performance with sensitive materials
- **Material conversion** at the nanoscale: direct heat-induced modifications (phase change, chemical reaction, ...) of various materials

# NanoFrazor Explore

## SYSTEM SPECIFICATIONS

|  | Thermal Probe Writing   | Direct Laser Sublimation |
|--|---|--------------------------|
| <b>Writing performance</b>   |   |                          |
| Minimum structure size [nm]  | 15  | 600                      |
| Minimum lines and spaces [half pitch, nm]  | 25  | 1000                     |
| Grayscale / 3D-resolution (step size in PPA) [nm]  | 2   | -                        |
| Writing field size [X $\mu\text{m}$ x Y $\mu\text{m}$ ]  | 60 x 60   | 60 x 60                  |
| Field stitching accuracy (markerless, using in-situ AFM imaging) [nm]  | 25  | 300                      |
| Overlay accuracy (markerless, using in-situ AFM imaging) [nm]  | 25  | 100                      |
| Write speed (typical scan speed) [mm/s]  | 1   | 5                        |
| Write speed (thermal Probe: 50 nm pixel, incl. imaging) [ $\mu\text{m}^2/\text{min}$ ]                         | 1000  | 100 000                  |
| <b>AFM imaging performance</b>   |   |                          |
| Lateral imaging resolution (feature size) [nm]   |   | 10                       |
| Vertical resolution (topography sensitivity) [nm]  |   | 0.2                      |
| Imaging speed (50 nm pixel) [ $\mu\text{m}^2/\text{min}$ ]   |   | 1000                     |
| <b>System features</b>   |   |                          |
| Substrate sizes  | 1 x 1 mm <sup>2</sup> to 100 x 100 mm <sup>2</sup> , 0 – 20 mm thickness<br>(150 x 150 mm <sup>2</sup> possible with limitations)   |                          |
| Optical microscope   | 0.6 $\mu\text{m}$ optical resolution, 1.0 mm x 1.0 mm field of view, autofocus  |                          |
| Laser source and optics  | 405 nm wavelength CW fiber laser, up to 150 mW output power on sample, 1.2 $\mu\text{m}$ minimum focal spot size  |                          |
| Real-time laser autofocus  | Using the distance sensor of the NanoFrazor cantilever  |                          |
| Magnetic cantilever holder   | Fast (< 1 min) and accurate tip exchange  |                          |
| Housing  | Three-layer acoustic isolation, superior vibration isolation (> 98% @ 10 Hz)<br>PC-controlled temperature and humidity monitoring, gas-flow regulation  |                          |
| Software features  | GDS and bitmap import, 0.1 nm address grid, 256 grayscale levels, AFM image analysis and drawing for overlay, mix & match between tip and laser writing, fully automated calibration routines, Python scripting |                          |
| <b>NanoFrazor cantilever features</b>  |   |                          |
| Integrated components  | Tip heater, topography sensor, electrostatic actuation  |                          |
| Tip geometry   | Conical tip with < 10 nm radius and 750 nm length   |                          |
| Tip heater temperature range   | 25 °C – 1100 °C (< 1 K setpoint resolution)   |                          |
| <b>System dimensions &amp; installation requirements</b>   |   |                          |
| Height x width x depth   | 185 cm x 78 cm x 128 cm   |                          |
| Weight   | 650 kg  |                          |
| Power input  | 1 x 110 or 220 V AC, 10 A   |                          |
| Gas input  | Compressed air and/or nitrogen with > 4 bar   |                          |
| <b>Other considerations</b>  |   |                          |
| Recipe book with detailed descriptions of various processes is included (regularly updated with software).     |   |                          |
| Cantilever tips degrade over time (> 50 h patterning possible). Exchange is fast and low cost for tool owners. |   |                          |
| A clean room or special laboratory is not required. No vacuum needed.  |   |                          |
| Multi-tip extension (optional add-on for Explore system) is scheduled for beta site testing in mid-2020.       |   |                          |

**Please note:** Specifications depend on individual process conditions and may vary according to equipment configuration. Write speed depends on pixel size and write mode. Design and specifications are subject to change without prior notice.

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